

L Number	Hits	Search Text	DB	Time stamp
9	188	(transfer same matrix )and "spin coating"	USPAT	2002/04/30 11:11
10	24	(transfer same matrix same laser )and "spin coating"	USPAT	2002/04/30 09:42
16	24	(transfer same matrix same laser )and "spin coating"	USPAT	2002/04/30 09:54
17	1	(transfer same matrix same laser )and "spin coating"	JPO; DERWENT	2002/04/30 09:55
20	1	(transfer same matrix same laser )and "cvd"	JPO; DERWENT	2002/04/30 09:56
23	1	(transfer same matrix same laser )and "thermal evaporation"	JPO; DERWENT	2002/04/30 09:56
-	0	("6177151.uref.").PN.	USPAT; US-PGPUB	2002/04/18 13:16
-	0	6177151.uref.	USPAT; US-PGPUB	2002/04/18 13:16
-	0	6177151.urpn.	USPAT; US-PGPUB	2002/04/18 13:16
-	1	((("3745586"   "3978247"   "4064205"   "4245003"   "4702958"   "4752455"   "4895735"   "4970196"   "4987006"   "5156938"   "5171650"   "5173441"   "5256506"   "5292559"   "5308737"   "5492861"   "5567336"   "5725706"   "5725914"   "5736464"   "6060127").PN.) and (anneal etch)	USPAT; US-PGPUB	2002/04/18 13:18
-	5	((("3745586"   "3978247"   "4064205"   "4245003"   "4702958"   "4752455"   "4895735"   "4970196"   "4987006"   "5156938"   "5171650"   "5173441"   "5256506"   "5292559"   "5308737"   "5492861"   "5567336"   "5725706"   "5725914"   "5736464"   "6060127").PN.) and (volatil\$3 or "vapor pressure")	USPAT; US-PGPUB	2002/04/18 13:31
-	1	("4895735").PN.	USPAT; US-PGPUB	2002/04/18 15:54
-	23	4895735.URPN.	USPAT	2002/04/18 15:59
-	4	4895735.URPN. and matrix	USPAT	2002/04/18 15:55
-	1	("6025036").PN.	USPAT; US-PGPUB	2002/04/19 11:30
-	0	(118/723).CCLS.	USPAT; US-PGPUB	2002/04/19 11:35
-	2359	(118/723\$2).CCLS.	USPAT; US-PGPUB	2002/04/29 18:31
-	10	((118/723\$2).CCLS.) and (laser adj2 deposition)	USPAT; US-PGPUB	2002/04/19 11:43
-	1269	laser adj2 deposition	USPAT; US-PGPUB	2002/04/19 14:04
-	93	(laser adj2 deposition) and (anneal etch) with laser	USPAT; US-PGPUB	2002/04/19 12:10
-	4	4895735.URPN. and vaporization	USPAT	2002/04/19 13:26
-	1534	laser same ((temperature adj vaporization) or volatil\$3)	USPAT; US-PGPUB	2002/04/19 14:23
-	18	(laser adj2 deposition) same ((temperature adj vaporization) or volatil\$3)	USPAT; US-PGPUB	2002/04/19 14:16
-	1326	laser same ((temperature adj vaporization) or volatile)	USPAT; US-PGPUB	2002/04/19 14:24
-	57	(laser adj (deposition or ablation)) same ((temperature adj vaporization) or volatile)	USPAT; US-PGPUB	2002/04/19 14:46
-	0	(laser adj (deposition or ablation)) same ((pressure adj vaporization))	USPAT; US-PGPUB	2002/04/19 14:47
-	111	(laser adj (deposition or ablation)) same ((vaporization))	USPAT; US-PGPUB	2002/04/19 14:47
-	4	(laser adj (deposition or ablation)) same ((pressure adj vapor))	USPAT; US-PGPUB	2002/04/19 14:48
-	38536	h01i021\$.ipc.	USPAT; US-PGPUB	2002/04/21 14:20
-	43367	c23c016\$.ipc.	EPO; JPO; DERWENT	2002/04/21 14:22
-	701	(h01i021\$.ipc. c23c016\$.ipc.) and ((laser and deposit\$3))	EPO; JPO; DERWENT	2002/04/21 14:32
-	14	(h01i021\$.ipc. c23c016\$.ipc.) and ((laser and deposit\$3)) and ("vapor pressure")	EPO; JPO; DERWENT	2002/04/21 14:57
-	53	(h01i021\$.ipc. c23c016\$.ipc.) and (laser adj (ablation deposition))	EPO; JPO; DERWENT	2002/04/21 15:47

-	79	(h01I021\$.ipc. c23c016\$.ipc.) and ((laser and deposit\$3)) and (mixture dispersion)	EPO; JPO; DERWENT	2002/04/21 15:47
-	2	(h01I021\$.ipc. c23c016\$.ipc.) and (("laser deposition" or "laser ablation")) and (mixture dispersion)	EPO; JPO; DERWENT	2002/04/21 15:49
-	25	(h01I021\$.ipc. c23c016\$.ipc.) and (("laser deposition" or "laser ablation")) and (mixture dispersion matrix target)	EPO; JPO; DERWENT	2002/04/21 15:48
-	84	(h01I021\$.ipc. c23c016\$.ipc.) and (laser with (deposition ablation)) and (mixture dispersion matrix target)	EPO; JPO; DERWENT	2002/04/21 15:49
-	15	(h01I021\$.ipc. c23c016\$.ipc.) and (laser and (volatile volatility))	EPO; JPO; DERWENT	2002/04/21 15:41
-	3	4505949.URPN. and (volatil\$3)	USPAT	2002/04/21 15:42
-	25	(h01I021\$.ipc. c23c016\$.ipc.) and (laser adj (deposit\$3 ablat\$3)) and (mixture dispersion matrix target)	EPO; JPO; DERWENT	2002/04/21 15:56
-	110	(h01I021\$.ipc. c23c016\$.ipc.) and (laser with (deposit\$3 ablat\$3)) and (mixture dispersion matrix target)	EPO; JPO; DERWENT	2002/04/21 15:57
-	57	(h01I021\$.ipc. c23c016\$.ipc.) and (laser with (deposit\$3 ablat\$3)) and (mixture dispersion matrix )	EPO; JPO; DERWENT	2002/04/21 16:17
-	58	(h01I021\$.ipc. c23c016\$.ipc.) and (laser adj (ablat\$3 deposit\$3))	EPO; JPO; DERWENT	2002/04/21 16:14
-	59	(laser adj (deposit\$3 ablat\$3)) same volatil\$3	USPAT;	2002/04/21 17:00
-	1	(laser with (ablate ablation deposit deposition)) and (matrix with "addition polymer")	US-PGPUB USPAT;	2002/04/22 16:00
-	25	(laser adj (ablate ablation deposit deposition)) and ("addition polymer")	US-PGPUB USPAT;	2002/04/22 16:52
-	25	("addition polymer") and (laser adj (ablate ablation deposit deposition))	US-PGPUB USPAT;	2002/04/22 16:53
-	3	("addition polymer") same (laser adj (ablate ablation deposit deposition))	US-PGPUB USPAT;	2002/04/22 16:56
-	24	"laser ablation" and "addition polymer"	US-PGPUB USPAT;	2002/04/22 16:57
-	13	"laser ablation" and "addition polymer" and matrix	US-PGPUB USPAT;	2002/04/22 17:00
-	1	"laser deposition" and "addition polymer" same matrix	US-PGPUB USPAT;	2002/04/22 17:01
-	1	"laser deposition" and ("addition polymer" same matrix)	US-PGPUB USPAT;	2002/04/22 17:01
-	32	((((metal ceramic) adj particle) same (organic with coating)))	US-PGPUB USPAT;	2002/04/30 11:08
-	31	((((metal ceramic) adj particle) same (organic with coating)))	JPO; DERWENT	2002/04/22 17:42
-	1	"laser ablation" same "thermal evaporation"	JPO; DERWENT	2002/04/23 17:57
-	1	"laser ablation" and "thermal evaporation"	JPO; DERWENT	2002/04/23 17:57
-	14	"laser evaporation" same "thermal evaporation"	USPAT;	2002/04/23 17:57
-	67	"laser ablation" same "thermal evaporation"	US-PGPUB USPAT;	2002/04/23 18:10
-	14	"laser evaporation" same "thermal evaporation"	US-PGPUB USPAT;	2002/04/23 18:15
-	7	"laser evaporation" with "cvd"	US-PGPUB USPAT;	2002/04/23 18:17
-	9	"laser evaporation" same "cvd"	US-PGPUB USPAT;	2002/04/23 18:19
-	17054	(common known) with (dispersion mixture colloidal) with (coat coating form film)	US-PGPUB USPAT;	2002/04/23 18:23
-	2742	(common known) with (dispersion mixture colloidal) with (coat film deposit)	US-PGPUB USPAT;	2002/04/23 18:22
-	154	(common) with (dispersion) with (coating)	US-PGPUB USPAT;	2002/04/23 18:24
-	1	(common) with (dispersion) with (coating)with (evaporation deposition)	US-PGPUB USPAT;	2002/04/23 18:25
-	0	(common with coating with dispersion) and "laser evaporation"	US-PGPUB USPAT;	2002/04/23 18:27

-	0	(common with coating with mixture) and "laser evaporation"	USPAT; US-PGPUB	2002/04/23 18:27
-	2	(known with coating with mixture) and "laser evaporation"	USPAT; US-PGPUB	2002/04/23 18:28
-	0	"laser evaporation" and (apply with (dispersion or mixture))	USPAT; US-PGPUB	2002/04/23 18:30
-	526	(laser adj (deposition evaporation ablation)) and "spin coating"	USPAT; US-PGPUB	2002/04/23 18:31
-	1022	(laser adj (deposition evaporation ablation)) and (spin coating) and (cvd "chemical vapor deposition")	USPAT; US-PGPUB	2002/04/23 18:32
-	58	(laser adj (deposition evaporation ablation)) and (("spin coating") with(cvd "chemical vapor deposition"))	USPAT; US-PGPUB	2002/04/23 18:36
-	1	(laser adj (deposition evaporation ablation)).ti. and (("spin coating") with(cvd "chemical vapor deposition"))	USPAT; US-PGPUB	2002/04/23 18:37
-	1	(laser adj (deposition evaporation ablation)).ti. and (("spin coating") with(cvd "chemical vapor deposition" "jet vapor" "screen print" "sedimentation" ))	USPAT; US-PGPUB	2002/04/23 18:38
-	32	118/715 and "spin coating"	USPAT; US-PGPUB	2002/04/29 19:06
-	2369	(118/723\$2).CCLS.	USPAT; US-PGPUB	2002/04/29 18:31
-	42	118/723\$2 and "spin coating"	USPAT; US-PGPUB	2002/04/29 18:34
-	42	(118/723\$2 and "spin coating") and "spin coating"	USPAT; US-PGPUB	2002/04/29 18:38
-	5	118/716 and "spin coating"	USPAT; US-PGPUB	2002/04/29 18:45
-	113	118/716 and ("chemical vapor deposition" or "cvd")	USPAT; US-PGPUB	2002/04/29 18:48
-	12	118/716 and (("chemical vapor deposition" or "cvd") with mixture)	USPAT; US-PGPUB	2002/04/29 20:04
-	18	118/716 and (("chemical vapor deposition" or "cvd") with particle)	USPAT; US-PGPUB	2002/04/29 18:56
-	1	118/716 and (("chemical vapor deposition" or "cvd") with dispersion)	USPAT; US-PGPUB	2002/04/29 18:56
-	0	118/716 and (("spin coating") with dispersion)	USPAT; US-PGPUB	2002/04/29 18:56
-	0	118/716 and (("spin coating") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and (("thermal evaporation") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and (("sedimentation") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and (("ink jet") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and ((laser) with dispersion)	USPAT; US-PGPUB	2002/04/29 18:58
-	1	118/715 and ("spin coating" with target)	USPAT; US-PGPUB	2002/04/29 19:07
-	23	"spin coating" with target	USPAT; US-PGPUB	2002/04/29 19:48
-	1	118/716 and (("spin coating") with mixture)	USPAT; US-PGPUB	2002/04/30 11:08
-	106	((("spin coating") with mixture)	JPO; DERWENT	2002/04/29 20:06
-	12	((("spin coating") with mixture) and laser	JPO; DERWENT	2002/04/29 20:06